

Doc. Number :

- ☒ Tentative Specification
☐ Preliminary Specification
☐ Approval Specification

MODEL NO.: R315DCJ
SUFFIX: KS4

k

Customer:

APPROVED BY

SIGNATURE

Name / Title

Note

Please return 1 copy for your confirmation with your signature and comments.

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REVISION HISTORY

Version	Date	Page	Description
0.0	16 th ,Jul,2024	All	Spec. Ver.0.0 was first issued.

1. GENERAL DESCRIPTION

1.1 OVERVIEW

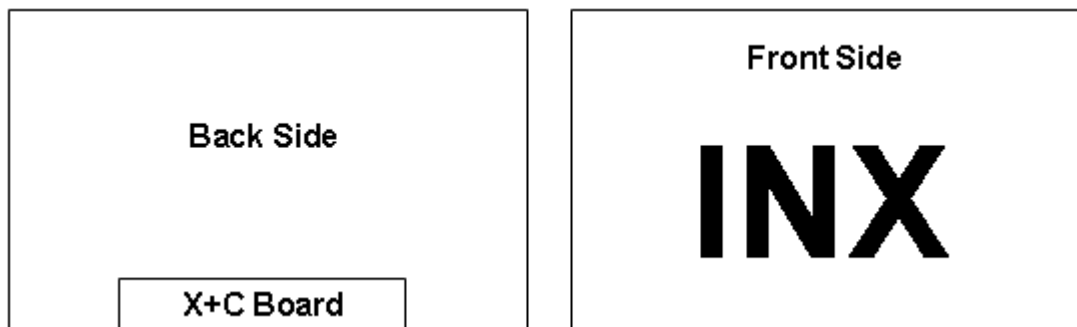
R315DCJ-KS4 is a 31.5" TFT Liquid Crystal Display medical module with WLED Backlight unit and 51 pins 8 lane – V by 1 interface. This module supports 3840 x 2160 UHD(Ultra High Definition) mode and can display up to 1.073G colors. The LCD module includes built-in converter for backlight and interlace led design for surgery application.

1.2 GENERAL SPECIFICATIONS

Item	Specification	Unit	Note
Screen Size	31.5" real diagonal	mm	
Driver Element	a-si TFT active matrix	-	-
Pixel Number	3840 x R.G.B. x 2160	pixel	-
Pixel Pitch	0.181 (H) x 0.181 (V)	mm	-
Pixel Arrangement	RGB vertical stripe	-	-
Display Colors	1.073G	color	-
Transmissive Mode	Normally Black	-	-
Surface Treatment	AG type, 3H hard coating, Haze 25	-	-
Color Gamut	102% of NTSC(Typ.)	-	-
Luminance, White	850	Cd/m2	
Power Consumption	Total (117.8) W(Typ.) @ cell (25.34) W(Typ.), BLU (92.4) W(Typ.)		(1)

Note (1) The specified power consumption : Total= cell (reference 4.3.1)+ Converter (reference 4.3.4)

Note (2)



2. MECHANICAL SPECIFICATIONS

Item		Min.	Typ.	Max.	Unit	Note
Module Size	Horizontal (H)	716.9	717.4	717.9	mm	(1)
	Vertical (V)	415.25	415.75	416.25	mm	
	Thickness (T)	23.4	24	24.6	mm	
Bezel Area	Horizontal	702.9	703.4	703.9	mm	
	Vertical	397.35	397.85	398.35	mm	
Active Area	Horizontal	-	697.31	-	mm	
	Vertical	-	392.23	-	mm	
Weight		(4427)	(4612)	(4796)	g	

Note (1) Please refer to the attached drawings for more information of front and back outline dimensions.

3. ABSOLUTE MAXIMUM RATINGS

3.1 ABSOLUTE RATINGS OF ENVIRONMENT

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Storage Temperature	TST	-20	60	°C	(1)
Operating Ambient Temperature	TOP	0	45	°C	(1), (2)

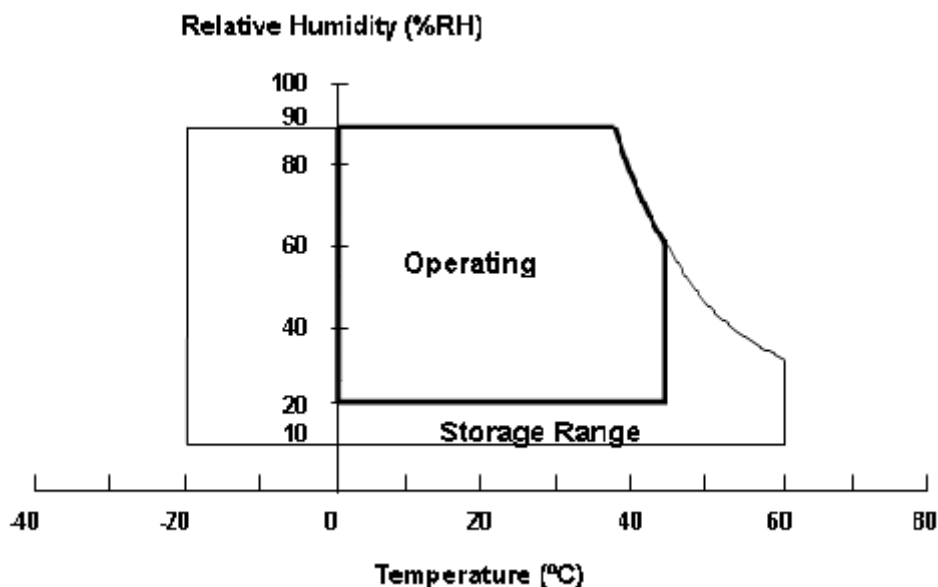
Note (1)

(a) 90 %RH Max..

(b) Wet-bulb temperature should be 39 °C Max.

(c) No condensation.

Note (2) Panel surface temperature should be 0°C min. and 60°C max.



3.2 ELECTRICAL ABSOLUTE RATINGS

3.2.1 TFT LCD MODULE

Item	Symbol	Value		Unit	Note
		Min.	Max.		
Power Supply Voltage	VCCS	-0.3	13.5	V	(1)
Logic Input Voltage	VIN	-0.3	3.6	V	

3.2.2 BACKLIGHT UNIT

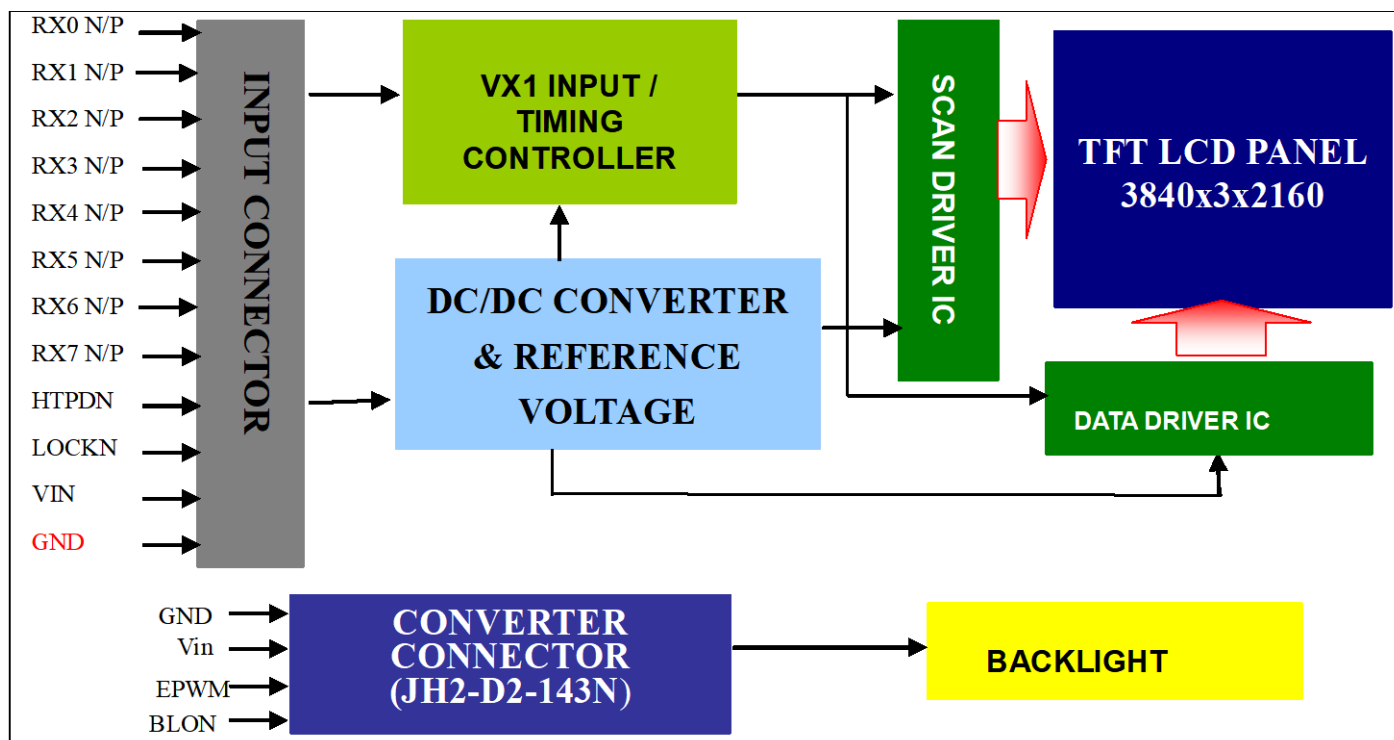
Item	Symbol	Value			Unit	Note
		Min.	Typ	Max.		
LED Forward Current Per Input Pin	IF	-	-	200	mA	(1), (2) Duty=100%

Note (1) Permanent damage to the device may occur if maximum values are exceeded. Function operation should be restricted to the conditions described under Normal Operating Conditions.

Note (2) Specified values are for input pin of LED light bar at $T_a=25\pm2\text{ }^{\circ}\text{C}$ (Refer to 4.3.3 and 4.3.4 for further information).

4. ELECTRICAL SPECIFICATIONS

4.1 FUNCTION BLOCK DIAGRAM



4.2. INTERFACE CONNECTIONS

PIN ASSIGNMENT

Pin	Name	Description	Note
1	Vin	Power input (+12V)	
2	Vin	Power input (+12V)	
3	Vin	Power input (+12V)	
4	Vin	Power input (+12V)	
5	Vin	Power input (+12V)	
6	Vin	Power input (+12V)	
7	Vin	Power input (+12V)	
8	Vin	Power input (+12V)	
9	N.C.	No Connection	(2)
10	GND	Ground	
11	GND	Ground	
12	GND	Ground	
13	GND	Ground	
14	GND	Ground	
15	N.C.	No Connection	(2)
16	N.C.	No Connection	(2)
17	N.C.	No Connection	(2)
18	N.C	For internal use, no connection	(2)
19	N.C	For internal use, no connection	(2)
20	N.C.	No Connection	(2)
21	N.C.	No Connection	(2)
22	N.C.	No Connection	(2)
23	N.C.	No Connection	(2)
24	N.C.	No Connection	(2)
25	HTPDN	Hot plug detect output, Open drain.	
26	LOCKN	Lock detect output, Open drain.	
27	GND	Ground	
28	RX0N	1 st Pixel Negative VbyOne differential data input in area A. Lan 0	(1)
29	RX0P	1 st Pixel Positive VbyOne differential data input in area A. Lan 0	
30	GND	Ground	
31	RX1N	2 nd Pixel Negative VbyOne differential data input in area A. Lan 1	(1)
32	RX1P	2 nd Pixel Positive VbyOne differential data input in area A. Lan 1	
33	GND	Ground	
34	RX2N	3 rd Pixel Negative VbyOne differential data input in area A. Lan 2	(1)
35	RX2P	3 rd Pixel Positive VbyOne differential data input in area A. Lan 2	
36	GND	Ground	
37	RX3N	4 th Pixel Negative VbyOne differential data input in area A. Lan 3	(1)
38	RX3P	4 th Pixel Positive VbyOne differential data input in area A. Lan 3	
39	GND	Ground	
40	RX4N	5 th Pixel Negative VbyOne differential data input in area A. Lan 4	(1)
41	RX4P	5 th Pixel Positive VbyOne differential data input in area A. Lan 4	
42	GND	Ground	
43	RX5N	6 th Pixel Negative VbyOne differential data input in area A. Lan 5	(1)
44	RX5P	6 th Pixel Positive VbyOne differential data input in area A. Lan 5	
45	GND	Ground	
46	RX6N	7 th Pixel Negative VbyOne differential data input in area A. Lan 6	(1)
47	RX6P	7 th Pixel Positive VbyOne differential data input in area A. Lan 6	
48	GND	Ground	

Pin	Name	Description	Note
49	RX7N	8 th Pixel Negative VbyOne differential data input in area A. Lan 7	(1)
50	RX7P	8 th Pixel Positive VbyOne differential data input in area A. Lan 7	
51	GND	Ground	

Connector Information

Item	Description
Manufacturer	FCN/ P-TWO
Type part number	FCN: WF23-402-5133 P-TWO: 187059-51221
User's Mating housing part number	JAE: FI-RE51HL

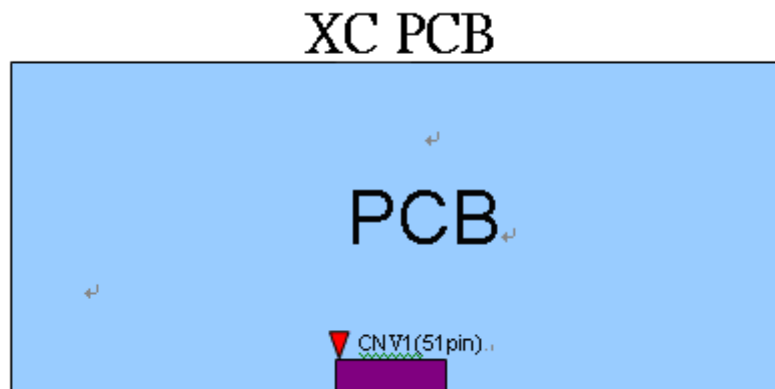
*Notice: There would be compatible issues if not using the indicated connectors in the matching list.

Note (1) V-by-One[®] HS Data Mapping

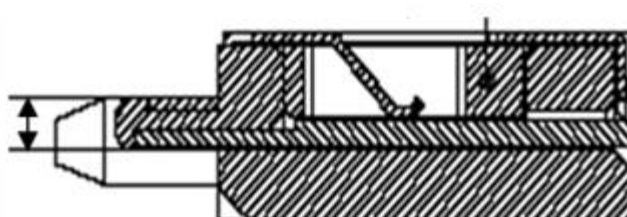
Lan	Data Stream
Lan 0	1, 9, 17,, 3825, 3833
Lan 1	2, 10, 18,, 3826, 3834
Lan 2	3, 11, 19,, 3827, 3835
Lan 3	4, 12, 20,, 3828, 3836
Lan 4	5, 13, 21,, 3829, 3837
Lan 5	6, 14, 22,, 3830, 3838
Lan 6	7, 15, 23,, 3831, 3839
Lan 7	8, 16, 24,, 3832, 3840

Note (2) Reserved for internal use. Please leave it open.

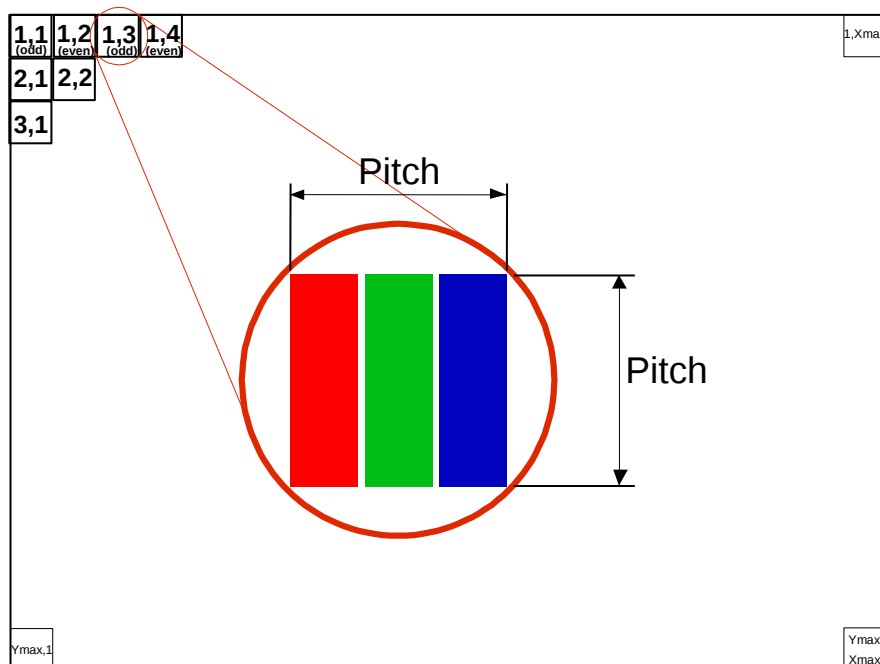
Note (3) V-by-One[®] HS connector pin order defined as following:



Note (4) V-by-One connector mating dimension range request is 0.93mm~1.0mm as below:



Note (5) Pixel should be arranged as the picture.



4.3 ELECTRICAL CHARACTERISTICS

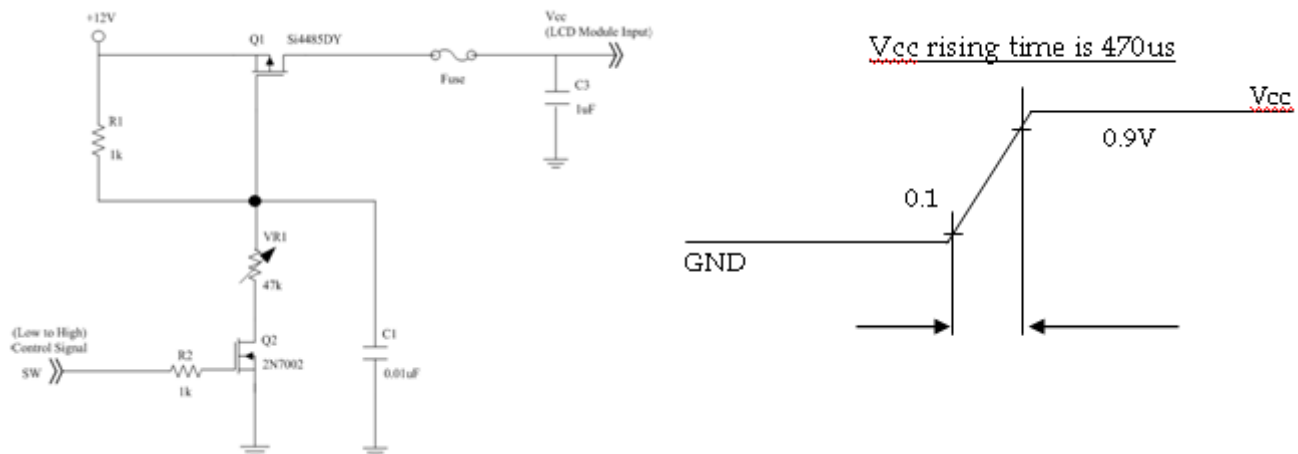
4.3.1 LCD ELETRONICS SPECIFICATION

(Ta = 25 ± 2 °C)

Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
Power Supply Voltage		V_{CC}	10.8	12	13.2	V	(1)
Rush Current		I_{RUSH}	—	—	(3)	A	(2)
Power Consumption	White Pattern	P_T	-	(25.34)	(30.61)	W	(3)
	Black Pattern	P_T	-	(11.47)	(13.91)	W	
	Horizontal Stripe	P_T	-	(24.32)	(29.68)	W	
Power Supply Current	White Pattern	—	—	(2.11)	(2.55)	A	(3)
	Black Pattern	—	—	(0.96)	(1.16)	A	
	Horizontal Stripe	—	—	(2.03)	(2.47)	A	
V-by-One HS	Differential Input High Threshold Voltage	$VLVTH$	—	—	+50	mV	
	Differential Input Low Threshold Voltage	$VLVTL$	-50	—	—	mV	
	Differential Input Resistor	$RRIN$	80	100	120	ohm	
CMOS interface	Input High Threshold Voltage	VIH	2.7	—	3.3	V	
	Input Low Threshold Voltage	VIL	0	—	0.7	V	

Note (1) The module should be always operated within the above ranges. The ripple voltage should be controlled under 10 % of Vcc (Typ.)

Note (2) Measurement Conditions



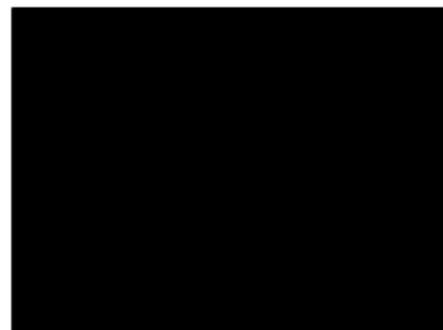
Note (3) The specified power supply current is under the conditions at Vcc = 12 V, Ta = 25 ± 2 °C, Fr = 60Hz, whereas a power dissipation check pattern below is displayed.

a. White Pattern



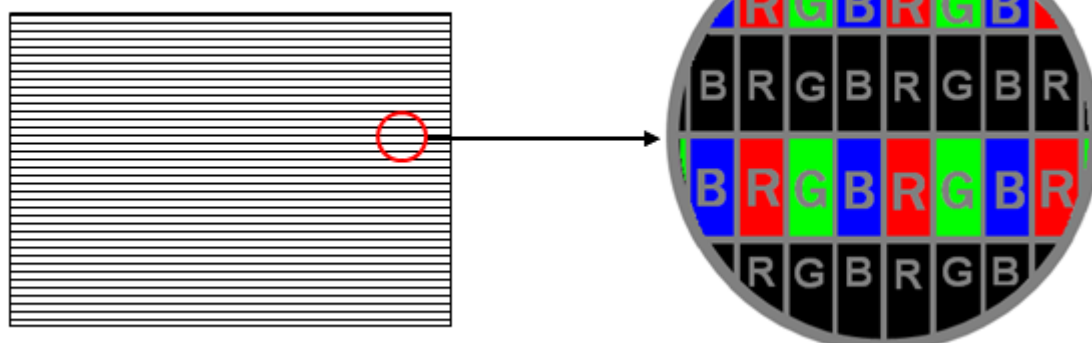
Active Area

b. Black Pattern

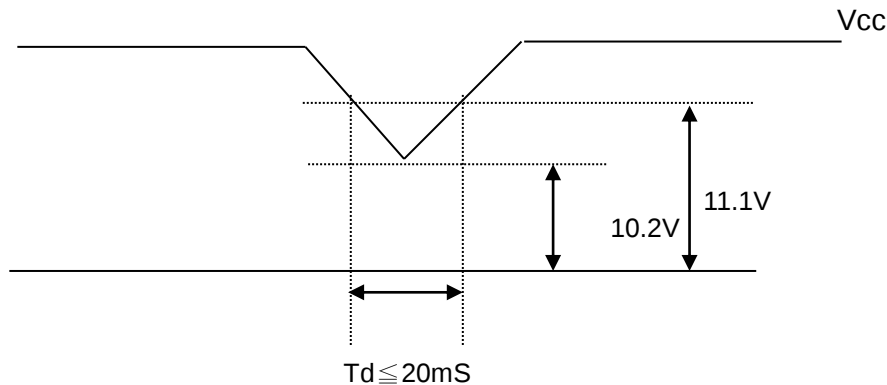


Active Area

c. Horizontal Pattern



4.3.2. Vcc Power Dip Condition



4.3.3. BACKLIGHT UNIT

Parameter	Symbol	Value			Unit	Note
		Min.	Typ.	Max.		
LED Light Bar Input Voltage Per Input Pin	VPIN	37.7	41.6	44.2	V	(1), Duty=100%, IPIN=125mA
LED Light Bar Current Per Input Pin	IPIN		(125)		mA	(1), (2) Duty=100%
LED Life Time	LLED	30000			Hrs	(3)
Power Consumption	PBL	-	(83.2)	(88.4)	W	(1) Duty=100%, IPIN=125mA

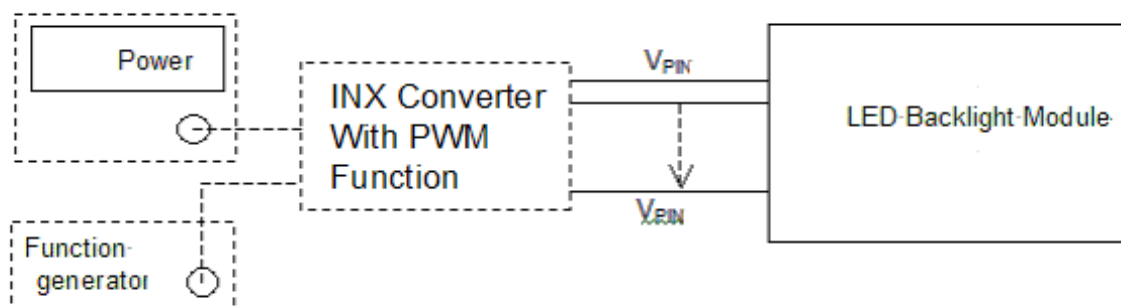
Note (1) LED light bar input voltage and current are measured by utilizing a true RMS multimeter as shown below:

Note (2) $PBL = IPIN \times VPIN \times (16)$ input pins.

Note (3) The lifetime of LED is estimated data and defined as the time when LED packages continue to operate under the conditions at $T_a = 25 \pm 2^\circ\text{C}$ and $I = 125\text{ mA}$ (per chip) until the brightness becomes $\leq 50\%$ of its original value. Operating LED under high temperature environment will reduce life time and lead to color shift.

Note (4) The module must be operated with constant driving current.

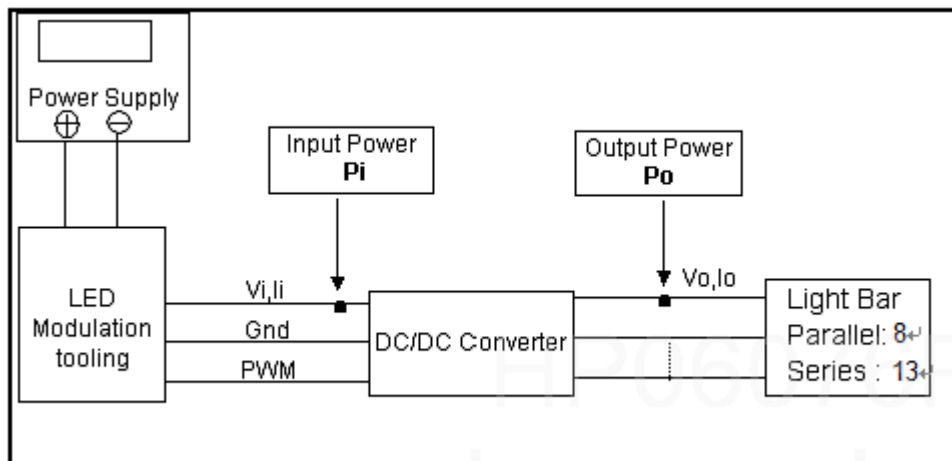
Note (5) If converter has PWM function, the PWM Frequency setting must be equal to 200Hz.



4.3.4 CONVERTER ELECTRICAL CHARACTERISTICS

Parameter		Symbol	Value			Unit	Note
			Min.	Typ.	Max.		
(Converter input voltage)		V_i	21.6	24.0	26.4	V_{DC}	(Duty 100%)
(Converter input ripple voltage)		V_{IRP}	-	-	500	mV	
(Converter input current)		I_i	-	(3.85)	(4.2)	A_{DC}	@ $V_i = 24V$ (Duty 100%)
(Converter inrush current)		I_{IRUSH}	-	-	3.0	A	@ V_i rising time=20ms ($V_i=24V$)
Input Power Consumption		P_i	-	(92.4)	(100.8)	W	(1)
EN Control Level	Backlight on	ENLED (BLON)	2.5	3.3	5.0	V	
	Backlight off		0	-	0.3	V	
PWM Control Level	PWM High Level	Dimming (E_PWM)	2.5	-	5.0	V	
	PWM Low Level		0	-	0.15	V	
PWM Noise Range		V_{Noise}	-	-	0.1	V	
PWM Control Frequency		f_{PWM}	190	200	20K	Hz	(3)
PWM Control Duty Ratio		-	5	-	100	%	(3), @ $190Hz < f_{PWM} < 1kHz$
			20	-	100	%	(3), @ $1kHz \leq f_{PWM} < 20kHz$
LED Life Time		L_{LED}	30000	-	-	Hrs	(2)

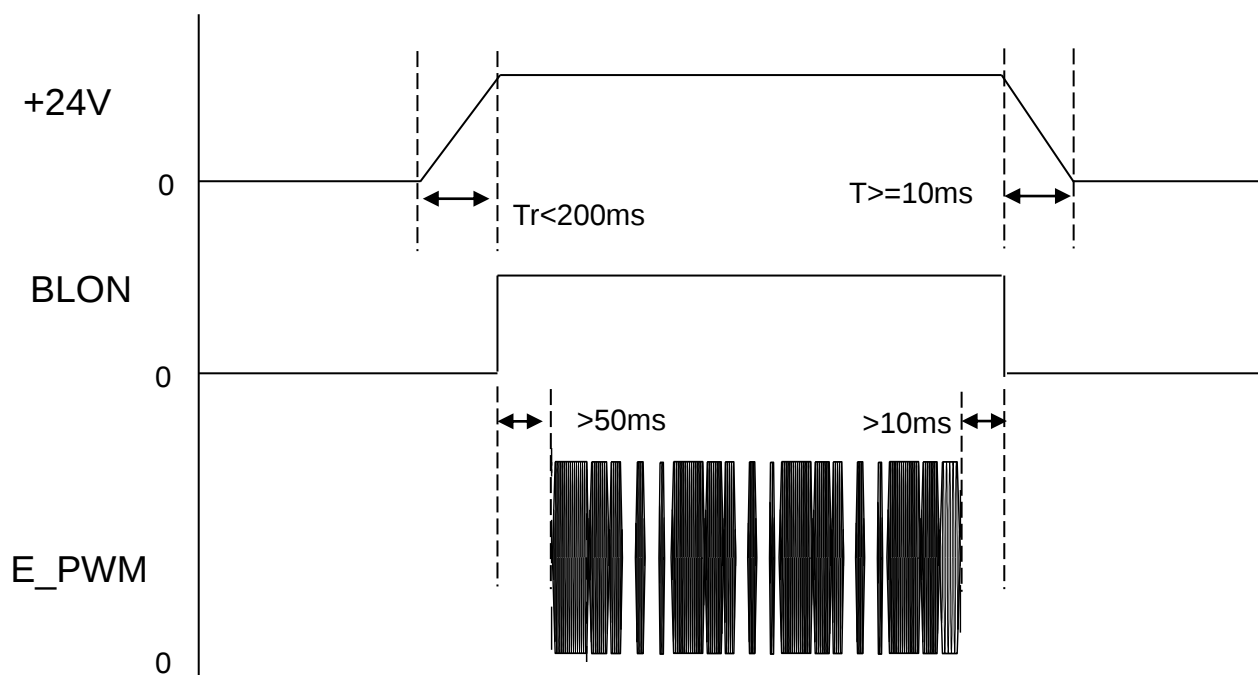
Note (1) LED current is measured by utilizing a high frequency current meter as shown below:



Note (2) The lifetime of LED is estimated data and defined as the time when it continues to operate under the conditions at $T_a = 25 \pm 2^\circ C$ and Duty 100% until the brightness becomes $\leq 50\%$ of its original value. Operating LED at high temperature condition will reduce life time and lead to color shift.

Note (3) At 190 ~1kHz PWM control frequency, duty ratio range is restricted from 5% to 100%. 1K ~20kHz PWM control frequency, duty ratio range is restricted from 20% to 100%.

If PWM control frequency is applied in the range from 1KHz to 20KHZ, The “non-linear” phenomenon on the Backlight Unit may be found. So It's a suggestion that PWM control frequency should be less than 1KHz.



Note : While system is turned ON or OFF, the power sequences must follow as below descriptions

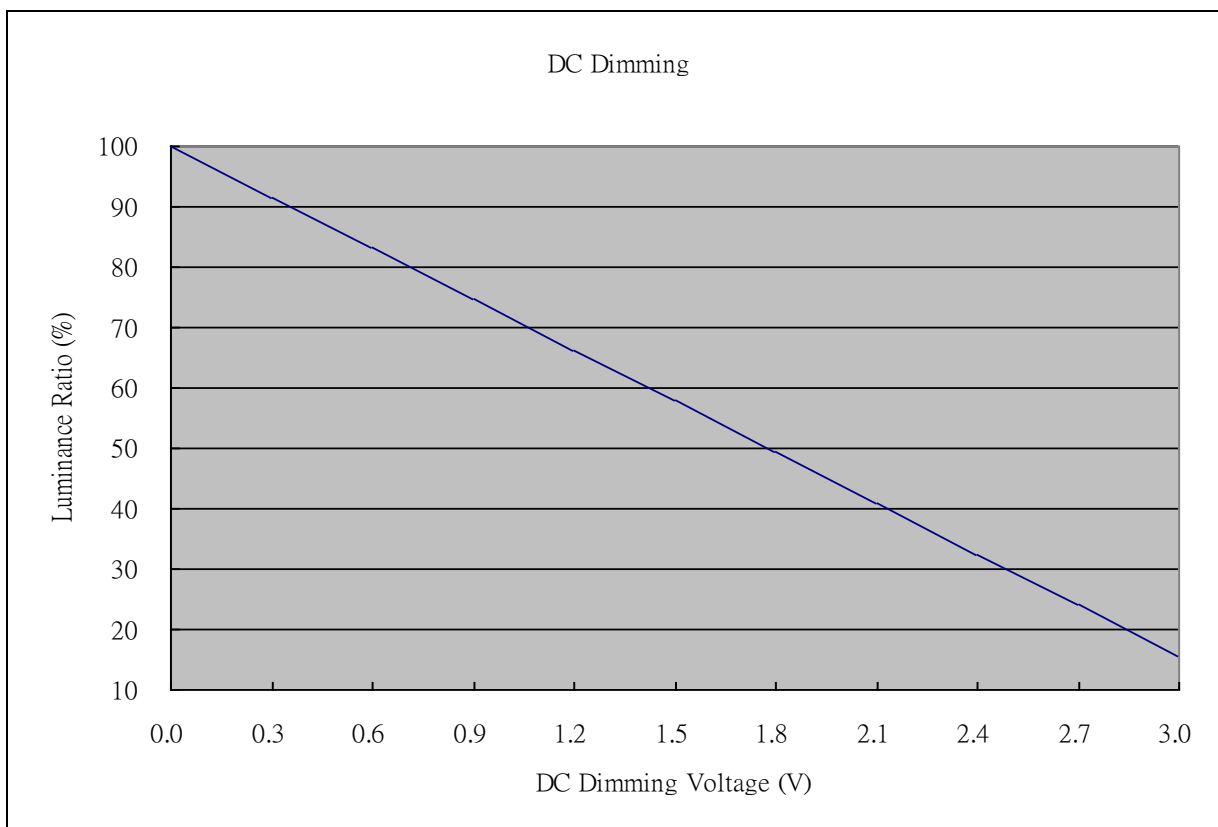
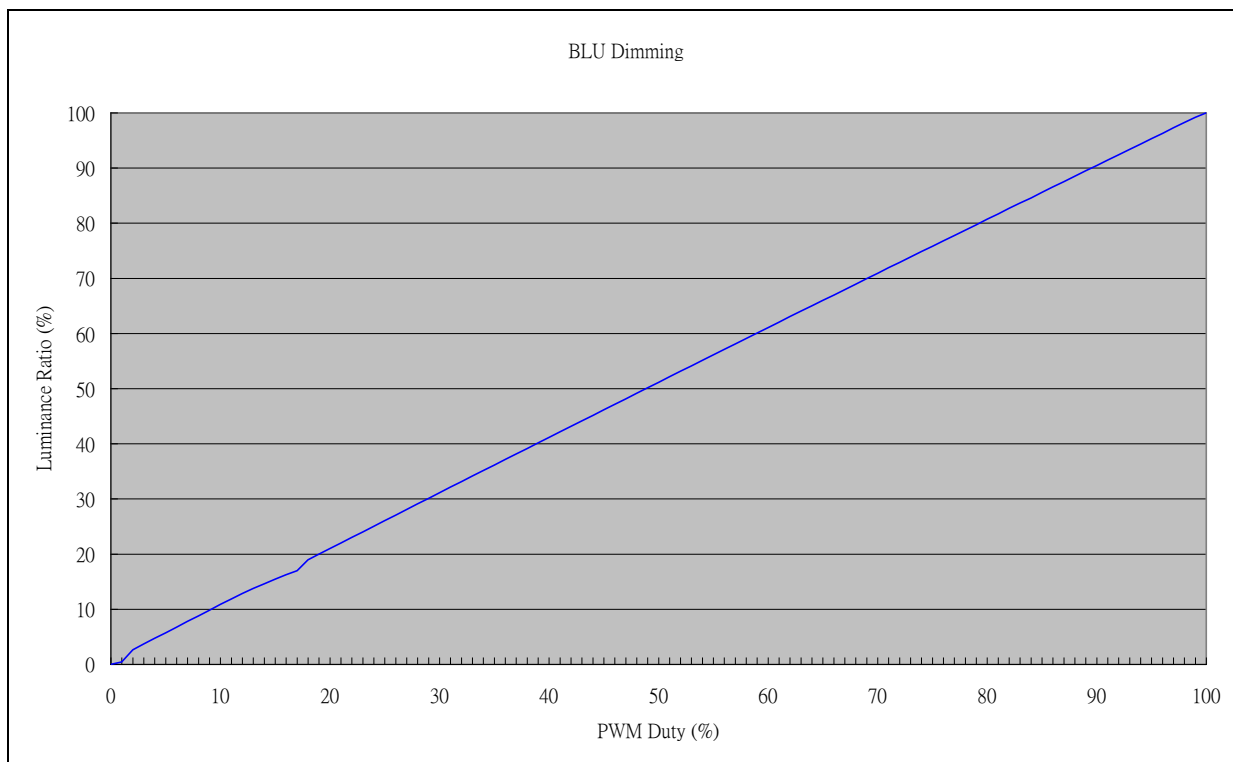
Turn ON sequence: $V_i(+24\text{V}) \rightarrow \text{BLON} \rightarrow \text{E_PWM signal}$

Turn OFF sequence: $\text{E_PWM signal} \rightarrow \text{BLON} \rightarrow V_i(+24\text{V})$

The definition of T_r : the time period of $10\% \cdot V_i$ to $90\% \cdot V_i$

The definition of T_f : the time period of $90\% \cdot V_i$ to $10\% \cdot V_i$

The following chart is the BLU Dimming for your reference.



4.3.5 CONVERTER INPUT CONNECTOR PIN ASSIGNMENT

Connector: FCN JH2-D4-143N or equivalent

Pin No	Signal name	Feature
1	V _{BL}	+24 V
2		
3		
4		
5		
6	GND	GND
7		
8		
9		
10		
11	DC_Dimming	DC Dimming (Hi: 3V _{DC} , Lo: 0V _{DC})
12	BLON	BL ON/OFF (ON:3.3V, OFF:0V)
13	SEL	DC_Dimming : Hi 3.3V; PWM_Dimming : Lo 0V
14	E_PWM	External PWM Control (Hi Level: 3.3V, Lo Level: 0V)

4.4 V BY ONE INPUT SIGNAL SPECIFICATIONS

4.4.1 V BY ONE DATA MAPPING TABLE

Lan	Data Stream
Lan 0	1, 9, 17,, 3825, 3833
Lan 1	2, 10, 18,, 3826, 3834
Lan 2	3, 11, 19,, 3827, 3835
Lan 3	4, 12, 20,, 3828, 3836
Lan 4	5, 13, 21,, 3829, 3837
Lan 5	6, 14, 22,, 3830, 3838
Lan 6	7, 15, 23,, 3831, 3839
Lan 7	8, 16, 24,, 3832, 3840

4.4.2 COLOR DATA INPUT ASSIGNMENT

The brightness of each primary color (red, green and blue) is based on the 10-bit gray scale data input for the color. The higher the binary input, the brighter the color. The table below provides the assignment of color versus data input.

Color		Data Signal																									
		Red										Green										BLUE					
		R9	R8	G7	G6	R5	R4	R3	R2	R1	R0	G9	G8	G7	G6	G5	G4	G3	G2	G1	G0	B9	B8	B7	B6	B5	B4
Basic Colors	Black	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	Blue	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Cyan	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
	Magenta	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Yellow	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0
	White	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1	1
Gray Scale Of Red	Red(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(2)	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	...																										
	...																										
	Red(1021)	1	1	1	1	1	1	1	1	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1022)	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Red(1023)	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
Gray Scale Of Green	Green(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Green(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0
	Green(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	...																										
	...																										
	Green(1021)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0
	Green(1022)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0
	Green(1023)	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1	1	1	1	0	0	0	0	0	0	0
Gray Scale Of Blue	Blue(0) / Dark	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	Blue(1)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	Blue(2)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
	...																										
	...																										
	Blue(1021)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Blue(1022)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1
	Blue(1023)	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	1	1	1	1	1

Note (1) 0: Low Level Voltage, 1: High Level Voltage

4.5 DISPLAY TIMING SPECIFICATIONS

The input signal timing specifications are shown as the following table and timing diagram.

Signal	Item	Symbol	Min.	Typ.	Max.	Unit	Note
V by One	Frequency	Fc	70	74.25	80	MHz	(1)
	Intra-Pair skew		-0.3	-	0.3	UI	(2)
	Inter-Pair skew		-5	-	5	UI	(3)
	Spread spectrum modulation range	Fclkin_mod	Fclkin-0.5%	-	Fclkin+0.5%	MHz	(4)
	Spread spectrum modulation frequency	FSSM	-	-	30	KHz	
Vertical Display Term	Frame Rate	Fr	55	60	62.5	Hz	(5)(6)
	Total	Tv	2200	2250	2480	Th	Tv=Tvd+Tvb (7)
	Active Display	Tvd	2160	2160	2160	Th	-
	Blank	Tvb	40	90	320	Th	-
Horizontal Display Term	Total	Th	530	550	570	Tc	Th=Thd+Thb
	Active Display	Thd	480	480	480	Tc	-
	Blank	Thb	50	70	90	Tc	-

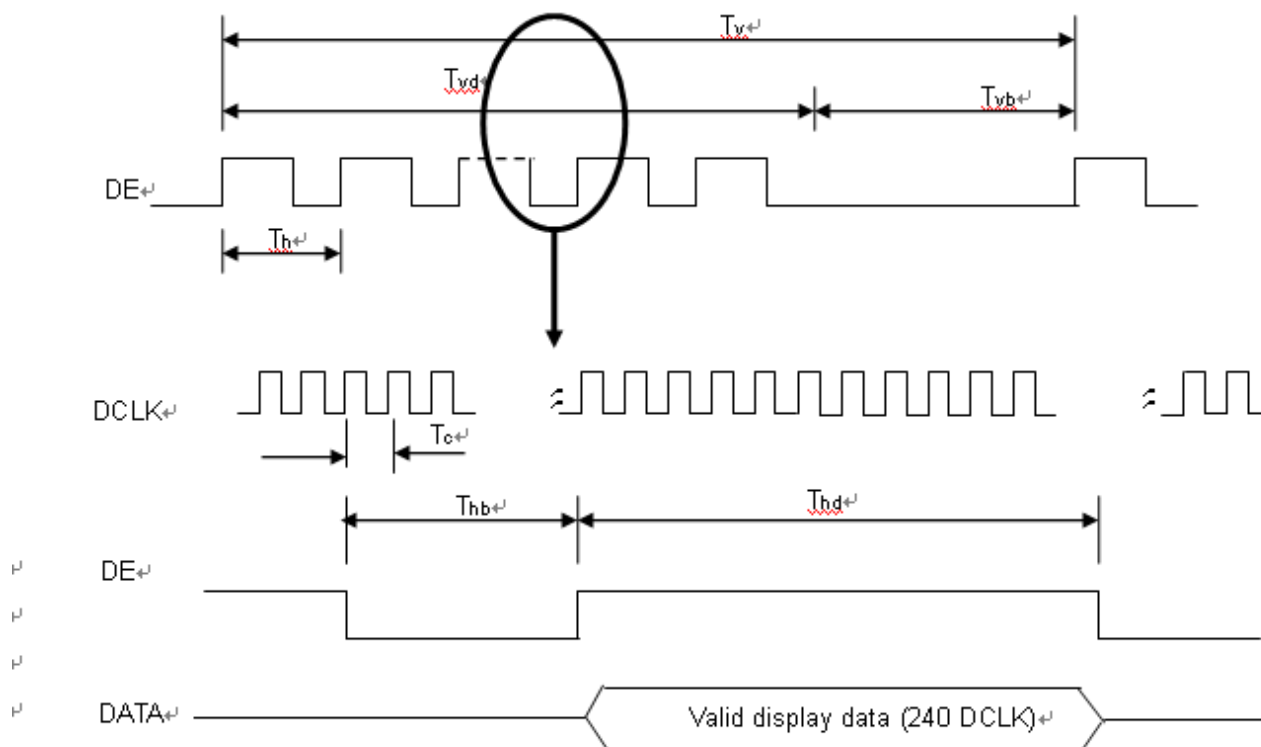
Note (1) Please make sure the range of pixel clock has follow the below equation:

$$F_{clkin}(\max) \geq Fr \times Tv \times Th$$

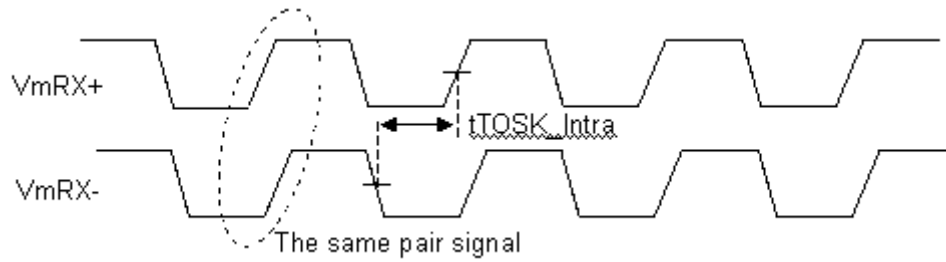
$$Fr \times Tv \times Th \geq F_{clkin}(\min)$$

INPUT SIGNAL TIMING DIAGRAM

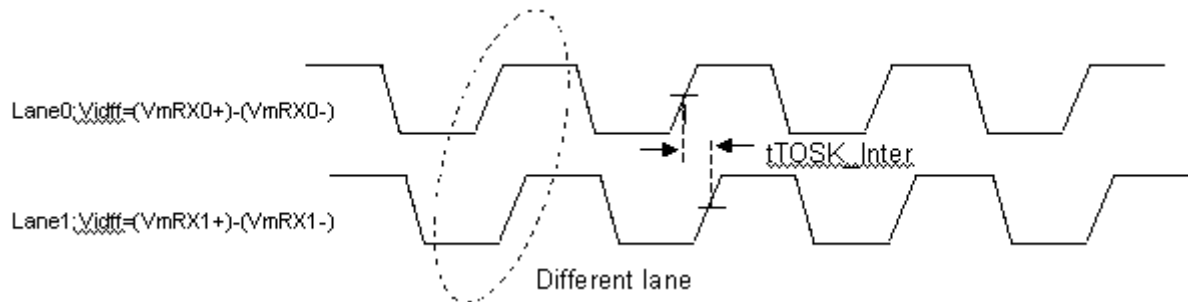
INPUT SIGNAL TIMING DIAGRAM



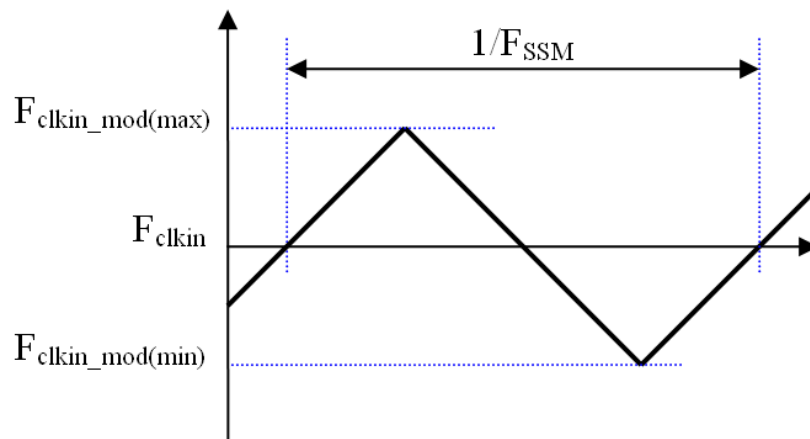
Note (2) V-by-One HS Intra-pair skew



Note (3) V-by-One HS Inter-pair skew

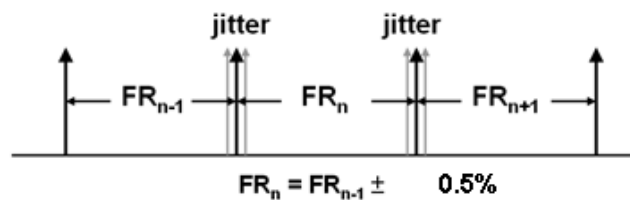


Note (4) The SSCG (Spread spectrum clock generator) is defined as below figures.



Note (5) The frame-to-frame jitter of the input frame rate is defined as the above figures. $FR_n = FR_{n-1} \pm 0.5\%$.

Note (6) The setup of the frame rate jitter $> 0.5\%$ may result in the cosmetic LED backlight symptom and the electric function is affected.



Note (7) The $T_v(T_{vd}+T_{vb})$ must be integer, otherwise, this module would operate abnormally.

4.6 V BY ONE INPUT SIGNAL TIMING DIAGRAM

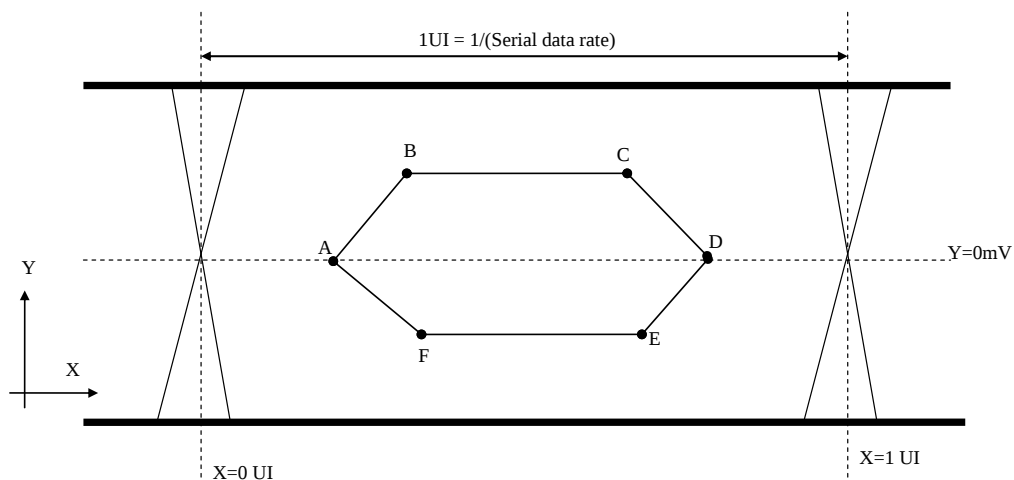


Table 1 Eye Mask Specification

	X [UI]	Y [mV]	Note
A	0.25	0	(1)
B	0.3	50	(1)
C	0.7	50	(1)
D	0.75	0	(1)
E	0.7	-50	(1)
F	0.3	-50	(1)

Note (1) Input levels of V-by-One HS signals are comes from “V-by-One HS Stander Ver.1.4”

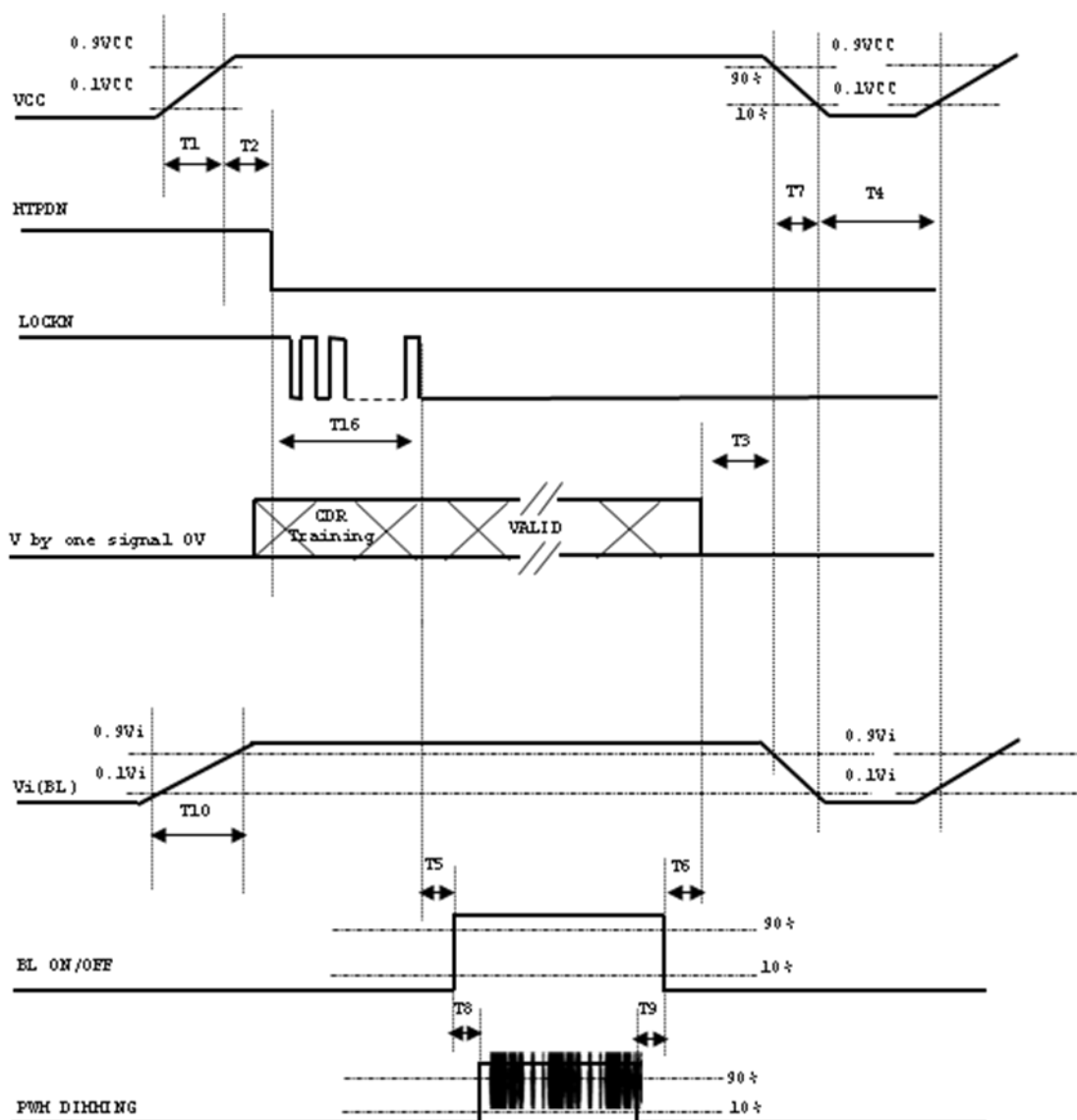
4.7 BYTE LENGTH AND COLOR MAPPING OF V-BY-ONE HS

Packer input & Unpacker output		30bpp RGB (10bit)
Byte 0	D[0]	R[2]
	D[1]	R[3]
	D[2]	R[4]
	D[3]	R[5]
	D[4]	R[6]
	D[5]	R[7]
	D[6]	R[8]
	D[7]	R[9]
Byte 1	D[8]	G[2]
	D[9]	G[3]
	D[10]	G[4]
	D[11]	G[5]
	D[12]	G[6]
	D[13]	G[7]
	D[14]	G[8]
	D[15]	G[9]
Byte 2	D[16]	B[2]
	D[17]	B[3]
	D[18]	B[4]
	D[19]	B[5]
	D[20]	B[6]
	D[21]	B[7]
	D[22]	B[8]
	D[23]	B[9]
Byte 3	D[24]	X
	D[25]	X
	D[26]	B[0]
	D[27]	B[1]
	D[28]	G[0]
	D[29]	G[1]
	D[30]	R[0]
	D[31]	R[1]

4.8 POWER ON/OFF SEQUENCE

($T_a = 25 \pm 2^\circ\text{C}$)

To prevent a latch-up or DC operation of LCD module, the power on/off sequence should be as the diagram below.



Parameter	Value			Units
	Min	Typ	Max	
T1	0.5	-	10	ms
T2	0	-	-	ms
T3	0	-	-	ms
T4	500	-	-	ms
T5	450	-	-	ms
T6	200	-	-	ms
T7	10	-	100	ms
T8	10	-	-	ms
T9	10	-	-	ms
T10	20	-	50	ms
T16	10	-	-	ms

Note (1) The supply voltage of the external system for the module input should follow the definition of Vcc.

Note (2) Apply the LED voltage within the LCD operation range. When the backlight turns on before the LCD operation or the LCD turns off before the backlight turns off, the display may momentarily become abnormal screen..

Note (3) In case of Vcc is in off level, please keep the level of input signals on the low or high impedance. If T2<0, that maybe cause electrical overstress failure.

Note (4) T4 should be measured after the module has been fully discharged between power off and on period..

Note (5) Interface signal shall not be kept at high impedance when the power is on

Note (6) Vcc must decay smoothly when power-off

5. OPTICAL CHARACTERISTICS

5.1 TEST CONDITIONS

Item	Symbol	Value	Unit
Ambient Temperature	Ta	25±2	oC
Ambient Humidity	Ha	50±10	%RH
Supply Voltage	According to typical value and tolerance in "ELECTRICAL CHARACTERISTICS"		
Input Signal			
LED Light Bar Input Current Per Input Pin			
PWM Duty Ratio	D	100	%
LED Light Bar Test Converter			

5.2 OPTICAL SPECIFICATIONS

The relative measurement methods of optical characteristics are shown here and all items are measured at the center point of screen unless otherwise noted. The following items should be measured under the test conditions described above and stable conditions shown in Note (5).

TItem		Symbol	Condition	Min.	Typ.	Max.	Unit	Note
-Color Chromaticity (CIE 1931)	Red	Rx	$\theta_x=0^\circ, \theta_Y =0^\circ$ CS-2000 R=G=B=255 Gray scale	Typ – 0.03	(0.685)	Typ + 0.03	-	(1), (5)
		Ry			(0.312)			
	Green	Gx			(0.243)			
		Gy			(0.702)			
	Blue	Bx			(0.152)			
		By			(0.038)			
	White	Wx			(0.313)			
		Wy			(0.329)			
	Center Luminance of White (Center of Screen)				L _C			
Contrast Ratio		CR	(1600)	(2000)	-	-	(2), (5)	
Response Time		T _R + T _F	$\theta_x=0^\circ, \theta_Y =0^\circ$	-	(16)	-	ms	(3)
White Variation		W	$\theta_x=0^\circ, \theta_Y =0^\circ$	--	-	1.33	--	(5), (6)
Viewing Angle	Horizontal	$\theta_{X-} + \theta_{X+}$	CR ≥ 10	160	178	-	Deg.	(1), (5)
	Vertical	$\theta_{Y-} + \theta_{Y+}$		160	178	-		

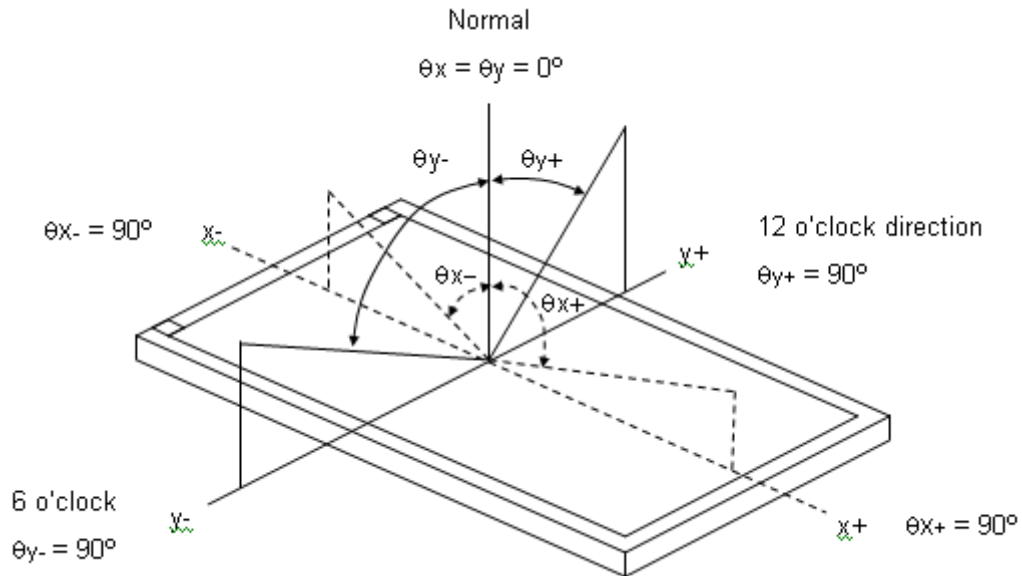
Definition :

Grayscale Maximum : Grayscale 255 (10 bits: grayscale 1023 ; 8 bits : grayscale 255 ; 6 bits: grayscale 63)

White : Luminance of Grayscale Maximum (All R,G,B)

Black : Luminance of grayscale 0 (All R,G,B)

Note (1) Definition of Viewing Angle (θ_x , θ_y):

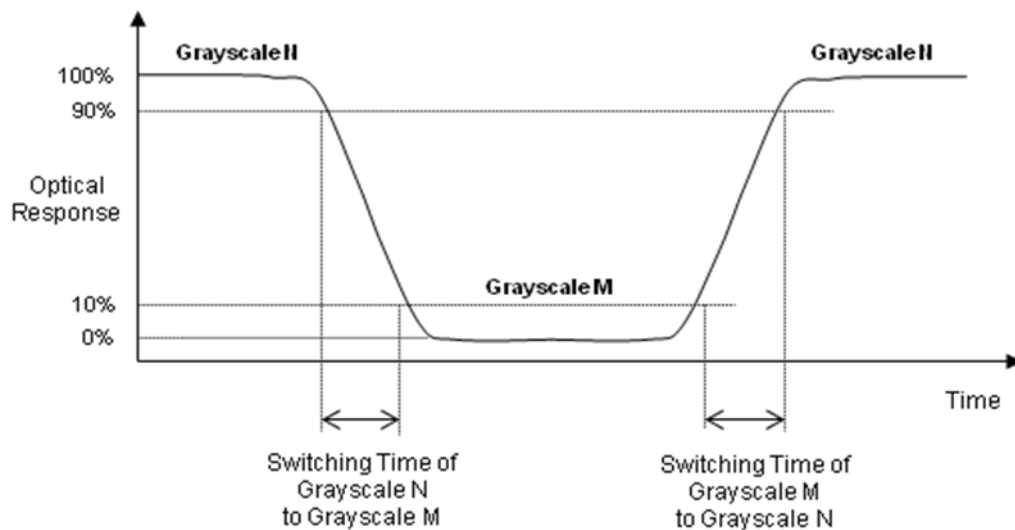


Note (2) Definition of Contrast Ratio (CR):

The contrast ratio can be calculated by the following expression at center point.

Contrast Ratio (CR) = White / Black

Note (3) Definition of Response Time (T_{GTG_AVE}):



N, M (separately) : Grayscale 0, 31, 63, 95, 127, 159, 191, 223 and 255 (8 bits), 9 levels.

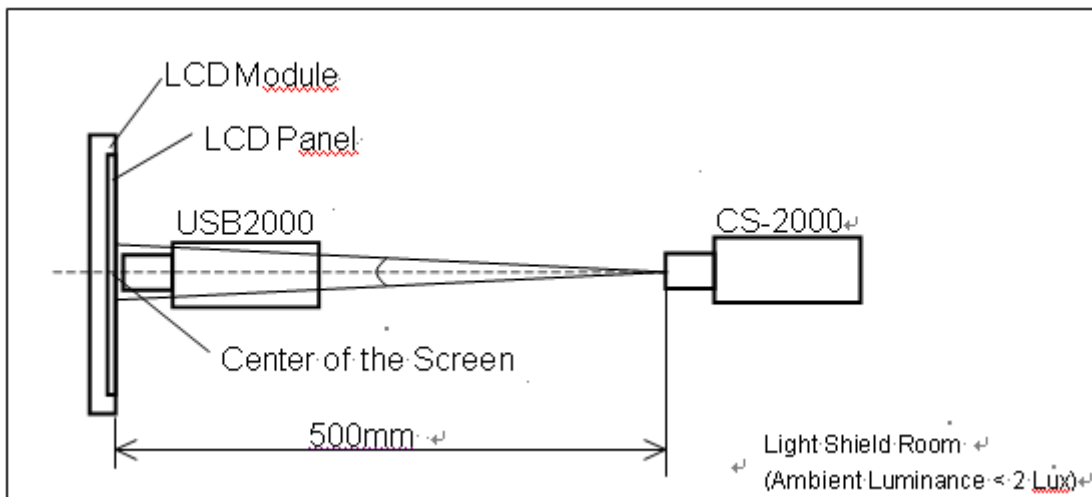
T_{GTG_AVE} : The total average of the T_{GTG} data which is switching time of grayscale N to M, 9x9 matrix except the same grayscales. It's measured by Innolux GTG instrument.

Note (4) Definition of Luminance of White (L_c):

Measure the luminance of White at center point

Note (5) Measurement Setup:

The LCD module should be stabilized at given temperature to avoid abrupt temperature change during measuring. In order to stabilize the luminance, the measurement should be executed after lighting Backlight for 60 minutes in a windless room.

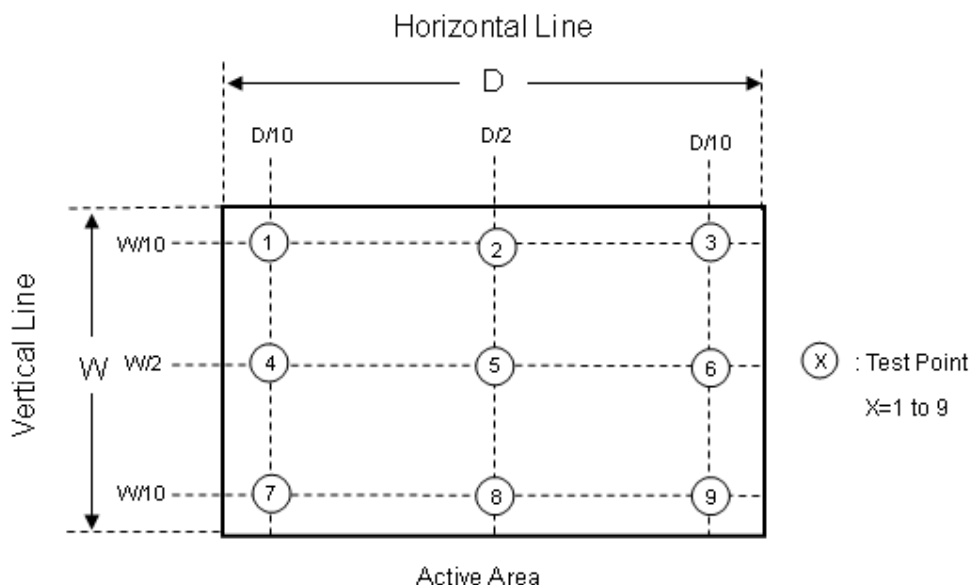


Note (6) Definition of White Variation (δW):

Measure the luminance of White at 9 points.

Luminance of White : $L(X)$, where X is from 1 to 9.

$$\delta W = \frac{\text{Maximum}[L(1), L(2), L(3), L(4), L(5), L(6), L(7), L(8), L(9)]}{\text{Minimum}[L(1), L(2), L(3), L(4), L(5), L(6), L(7), L(8), L(9)]}$$



6. RELIABILITY TEST ITEM

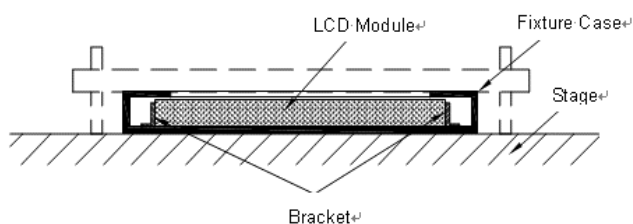
Items	Required Condition	Note
Temperature Humidity Bias (THB)	Ta= 50℃ , 80%RH, 240hours	
High Temperature Operation (HTO)	Ta= 45℃ , 240hours	
Low Temperature Operation (LTO)	Ta= 0℃ , 240hours	
High Temperature Storage (HTS)	Ta= 60℃ , 240hours	
Low Temperature Storage (LTS)	Ta= -20℃ , 240hours	
Vibration Test (Non-operation)	Acceleration: 1.5 G Wave: sine Frequency: 10 - 300 Hz Sweep: 30 Minutes each Axis (X, Y, Z)	
Shock Test (Non-operation)	Acceleration: 50 G Wave: Half-sine Active Time: 11 ms Direction : ± X, ± Y, ± Z.(one time for each Axis)	
Thermal Shock Test (TST)	-20℃/30min , 60℃ / 30min , 100 cycles	
On/Off Test	25℃ ,On/10sec , Off /10sec , 30,000 cycles	
ESD (Electro Static Discharge)	Contact Discharge: ± 8KV, 150pF(330Ω)	
	Air Discharge: ± 15KV, 150pF(330Ω)	
Altitude Test	Operation:10,000 ft / 24hours Non-Operation:30,000 ft / 24hours	

Note (1) criteria : Normal display image with no obvious non-uniformity and no line defect.

Note (2) Evaluation should be tested after storage at room temperature for more than two hour

Note (3) At testing Vibration and Shock, the fixture in holding the module has to be hard and rigid enough so that the module would not be twisted or bent by the fixture.

The fixing condition is shown as below:

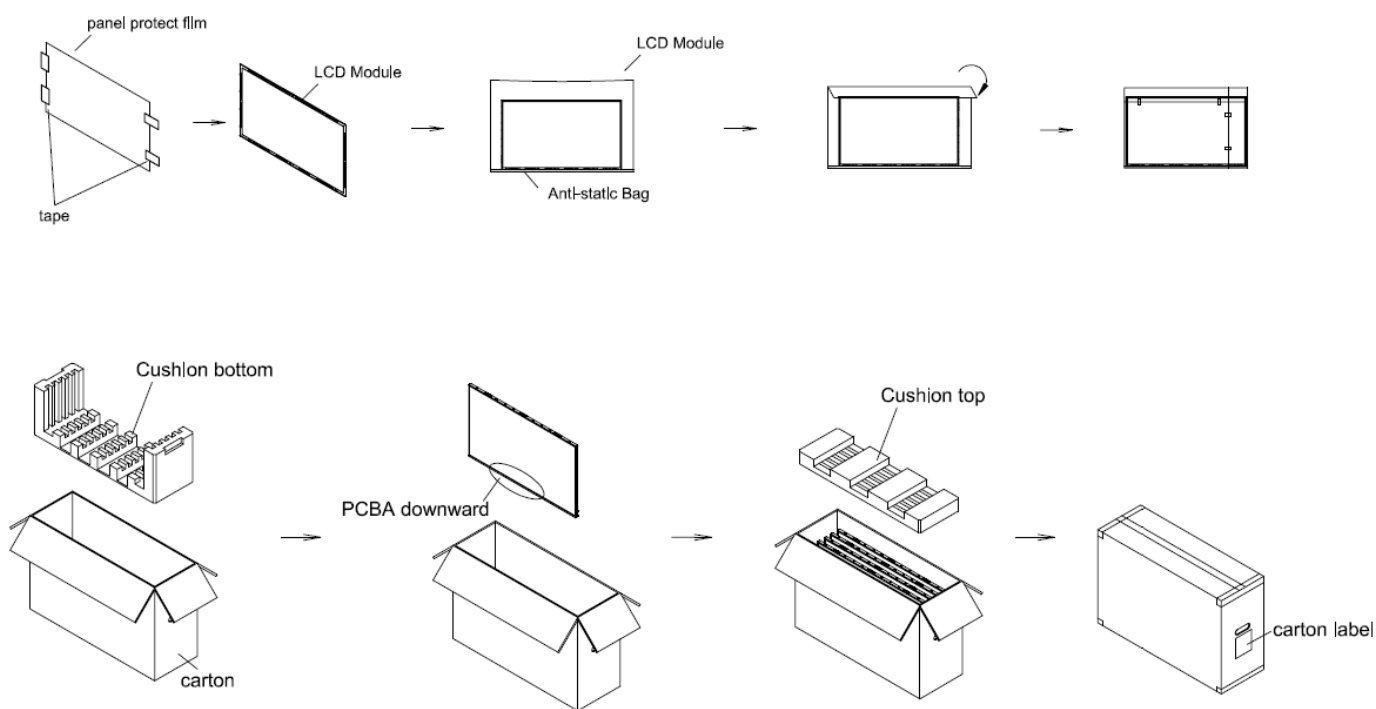


7. PACKING

7.1 PACKING SPECIFICATIONS

- (1) 5 LCD modules / 1 Box
- (2) Box dimensions: 835(L) X 285(W) X 540(H) mm
- (3) Weight: approximately: 24.78kg (typ.) (5 modules per box)

7.2 PACKING METHOD



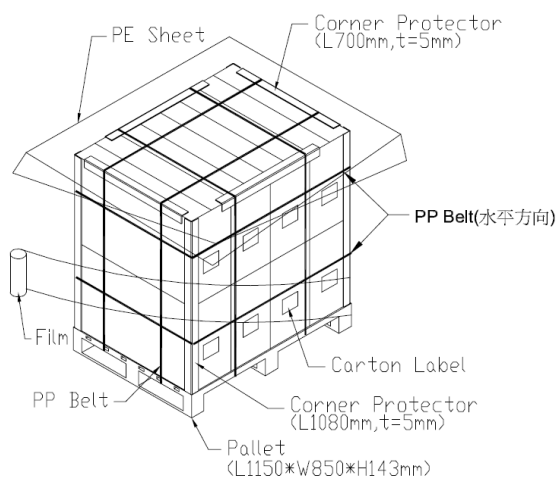
- (1) Carton dimensions: 835(L)x285(W)x540(H)mm
- (2) 5 modules / carton

Figure. 7-1 Packing method

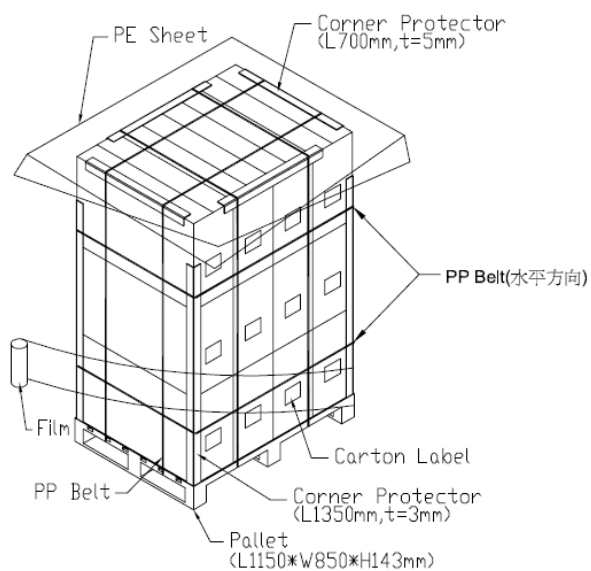
7.3 PALLET

For ocean shipping

Air Transportation 2 Layer



Sea / Land Transportation (40ft Container) 3 Layer



Sea / Land Transportation (40ft HQ Container) 2+2 Layer

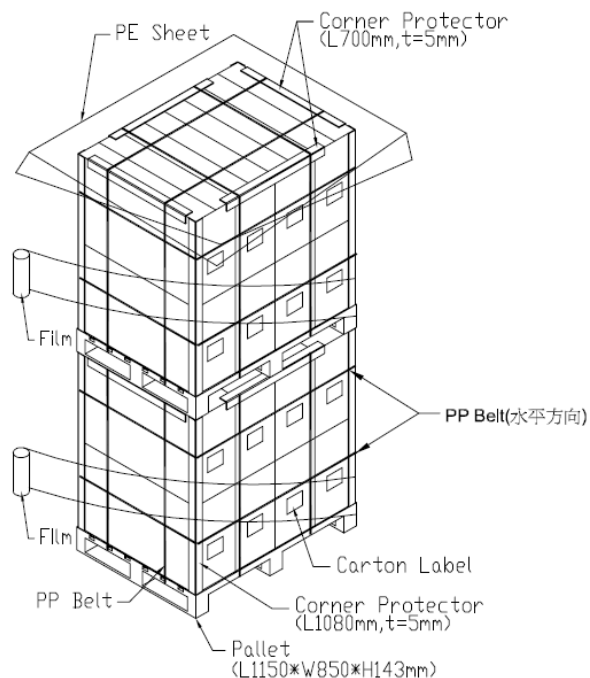


Figure. 7-2 Packing method

7.4 UN-PACKING METHOD

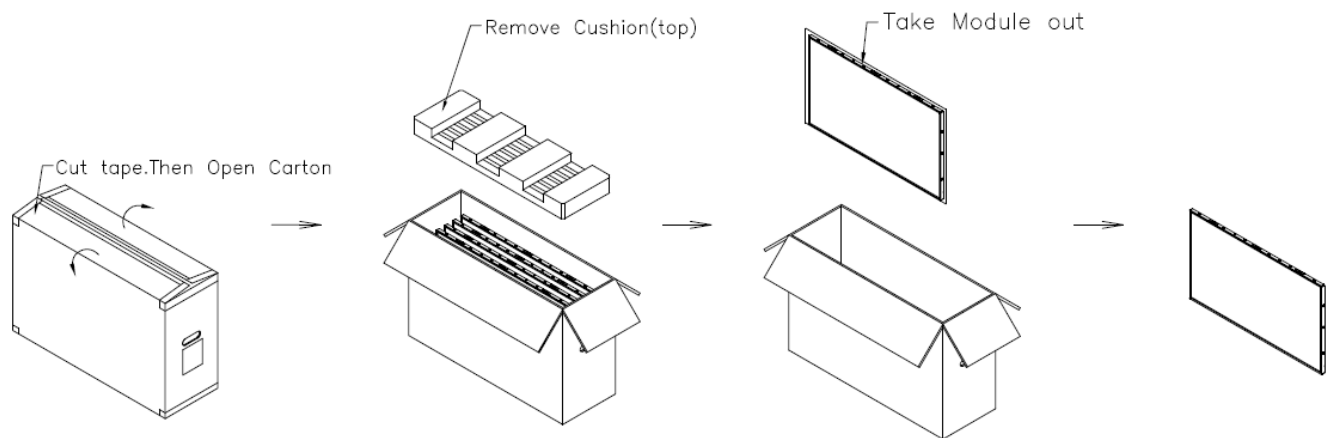
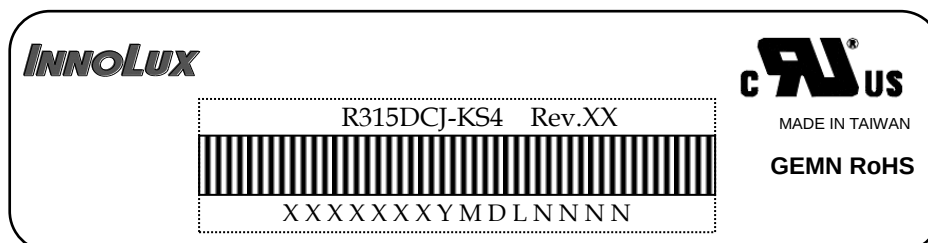


Figure. 7-3 UN-Packing method

8. INX MODULE LABEL

The barcode nameplate is pasted on each module as illustration, and its definitions are as following explanation.



(a) Model Name: R315DCJ-KS4

(b) Revision: Rev. XX, for example: A0, A1... B1, B2... or C1, C2...etc.

(c) InnoLux barcode definition:

Serial ID: XX-XX-X-XX-YMD-L-NNNN

Code	Meaning	Description
XX	InnoLux internal use	-
XX	Revision	Cover all the change
X	InnoLux internal use	-
XX	InnoLux internal use	-
YMD	Year, month, day	Year: 0~9, 2001=1, 2002=2, 2003=3...2010=0, 2011=1, 2012=2... Month: 1~12=1, 2, 3, ~, 9, A, B, C Day: 1~31=1, 2, 3, ~, 9, A, B, C, ~, W, X, Y, exclude I, O, and U.
L	Product line #	Line 1=1, Line 2=2, Line 3=3, ...
NNNN	Serial number	Manufacturing sequence of product

(d) FAB ID(UL Factory ID):

Region	Factory ID
TWINX	GEMN
NBCMI	LEOO
NBCMI	VIRO
NBCME	CANO
NHCM I	CAPG

9. PRECAUTIONS

9.1 ASSEMBLY AND HANDLING PRECAUTIONS

- (1) There should be no condensation on the surface of panel during test.
- (2) In the standard conditions, there is no function failure issue occurred. All the cosmetic Specification is judged before reliability test.
- (3) Before cosmetic and function test, the product must have enough recovery time, at least 24 hours at room temperature.
- (4) Be sure to turn off power supply when inserting or disconnecting from input connector.
- (5) To avoid ESD(Electro Static Discharge) damage, be sure to ground yourself before handling TFT-LCD Module.
- (6) Do not apply rough force such as bending or twisting to the module during assembly. TFT-LCD Module is not allowed to be twisted & bent even force is added on module in a very short time.
- (7) To assemble or install module into user's system can be only in clean working areas. The dust and oil may cause electrical short or worsen the polarizer.
- (8) It's not permitted to have pressure or impulse on the module because the LCD panel and Backlight will be damaged.
- (9) Always follow the correct power sequence when LCD module is connecting and operating. This can prevent damage to the CMOS LSI chips during latch-up.
- (10) Do not pull the I/F connector in or out while the module is operating.
- (11) Do not disassemble or modify the module.
- (12) Use a soft dry cloth without chemicals for cleaning, because the surface of polarizer is very soft and easily scratched.
- (13) It is dangerous that moisture come into or contacted the LCD module, because moisture may damage LCD module when it is operating.
- (14) High temperature or humidity may reduce the performance of module. Please store LCD module within the specified storage conditions.
- (15) When ambient temperature is lower than 10°C may reduce the display quality. For example, the response time will become slowly.
- (16) While touching the panel surface under the patterns with higher grey levels, a shadow or mura phenomenon would be seen. This phenomenon is totally recoverable by switching the patterns to lower grey levels. It is a product feature.
- (17) Continuous displaying fixed pattern will induce image sticking. It's recommended to use screen saver or shuffle content periodically if fixed pattern is displayed on the screen.

9.2 STORAGE PRECAUTIONS

- (1) Do not leave the module in high temperature, and high humidity for a long time. It is highly recommended to store the module with temperature from 0°C to 35°C and relative humidity of less than 70%.
- (2) Do not store the TFT – LCD module in direct sunlight.
- (3) The module should be stored in dark place. It is prohibited to apply sunlight or fluorescent light in storing.

9.3 OPERATION PRECAUTIONS

- (1) The LCD product should be operated under normal condition.
 Normal condition is defined as below :
 Temperature : $20 \pm 15^{\circ}\text{C}$
 Humidity: $65 \pm 20\%$
 Display pattern : continually changing pattern(Not stationary)
- (2) If the product will be used in extreme conditions such as high temperature, high humidity, high altitude, display pattern or operation time etc... It is strongly recommended to contact INX for application engineering advice. Otherwise, its reliability and function may not be guaranteed.
- (3) Display pattern: regular switched patterns or moving pictures
 Periodical power-off or screen saver is needed after long-term static display, moving picture or black pattern is strongly recommended for screen saver
- (4) The ambient temperature near the operated module should be satisfied with the absolute maximum ratings. Sufficient cooling system should be adopted to system.

9.4 SAFETY PRECAUTIONS

- (1) If the liquid crystal material leaks from the panel, it should be kept away from the eyes or mouth. In case of contact with hands, skin or clothes, it has to be washed away thoroughly with soap.
- (2) After the module's end of life, it is not harmful in case of normal operation and storage.

9.5 SAFETY STANDARDS

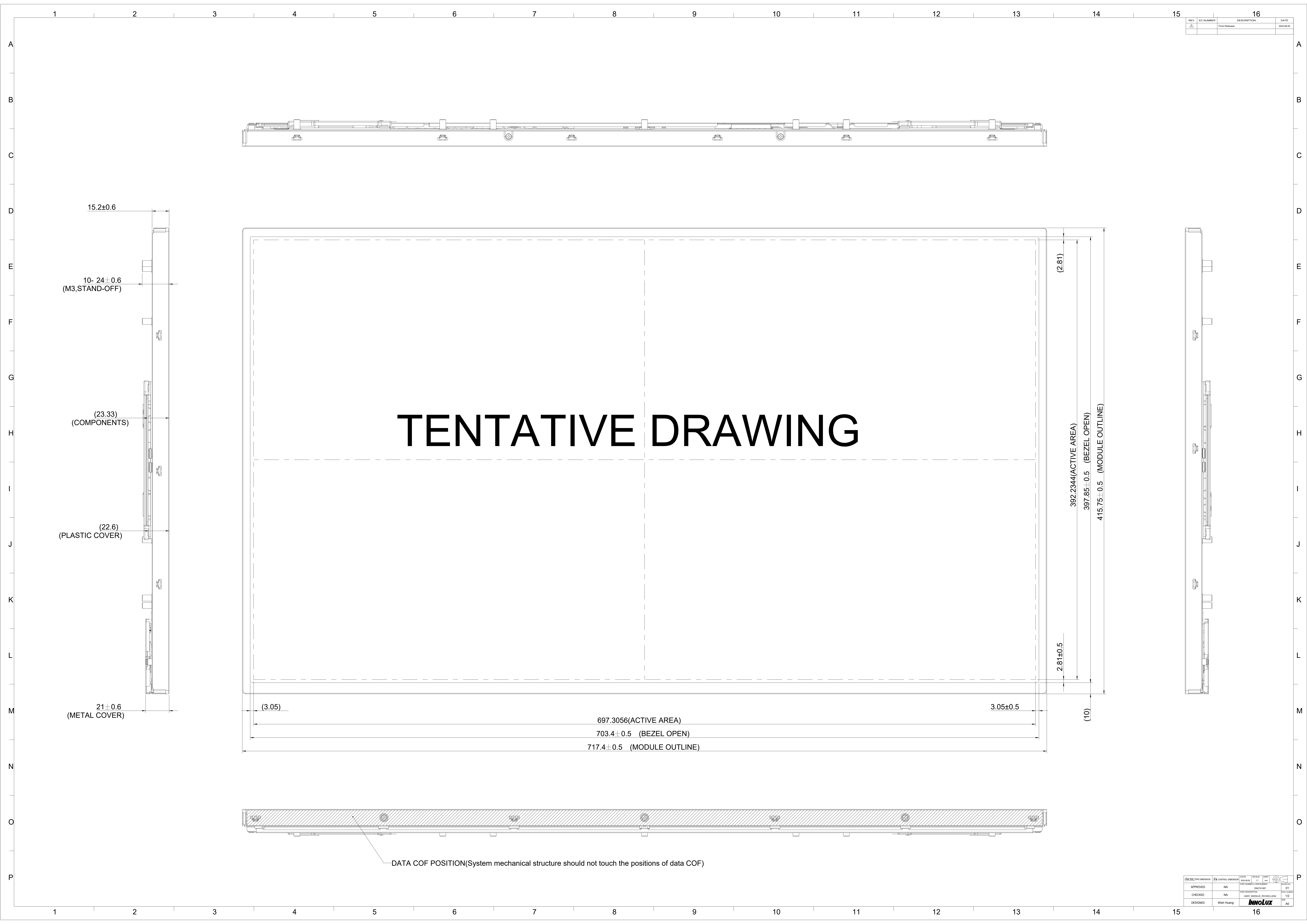
The LCD module should be certified with safety regulations as follows:

Requirement	Standard	remark
UL	UL62368-1 or updated standard.	
CB	IEC62368-1 or updated standard.	

9.6 OTHER

When fixed patterns are displayed for a long time, remnant image is likely to occur.

Appendix . OUTLINE DRAWING



REV	EC NUMBER	DESCRIPTION	DATE
Δ		First Release	2014-05-05

DESIGN DIMENSION	CONTROL DIMENSION	DATE	SCALE	UNIT	PROJECT
APPROVED	NA	2014-05-05	1:1	mm	B1
CHECKED	NA	2014-05-05			1/2
DESIGNED	Wish Huang	2014-05-05			A0

innolux

TENTATIVE DRAWING

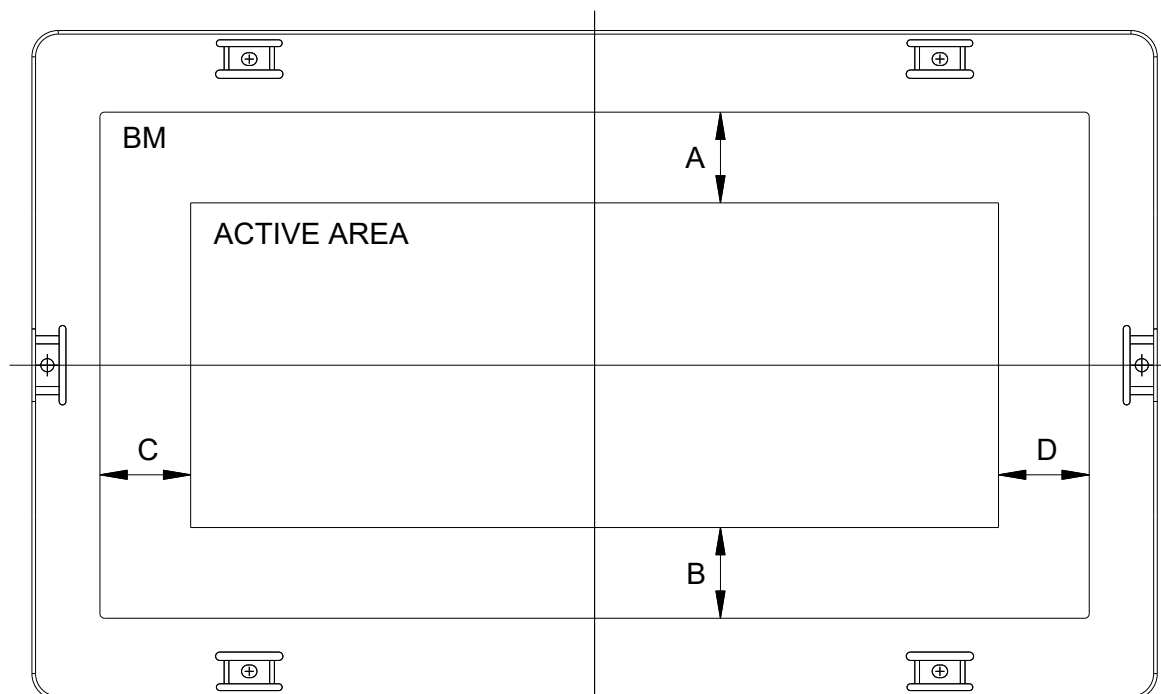
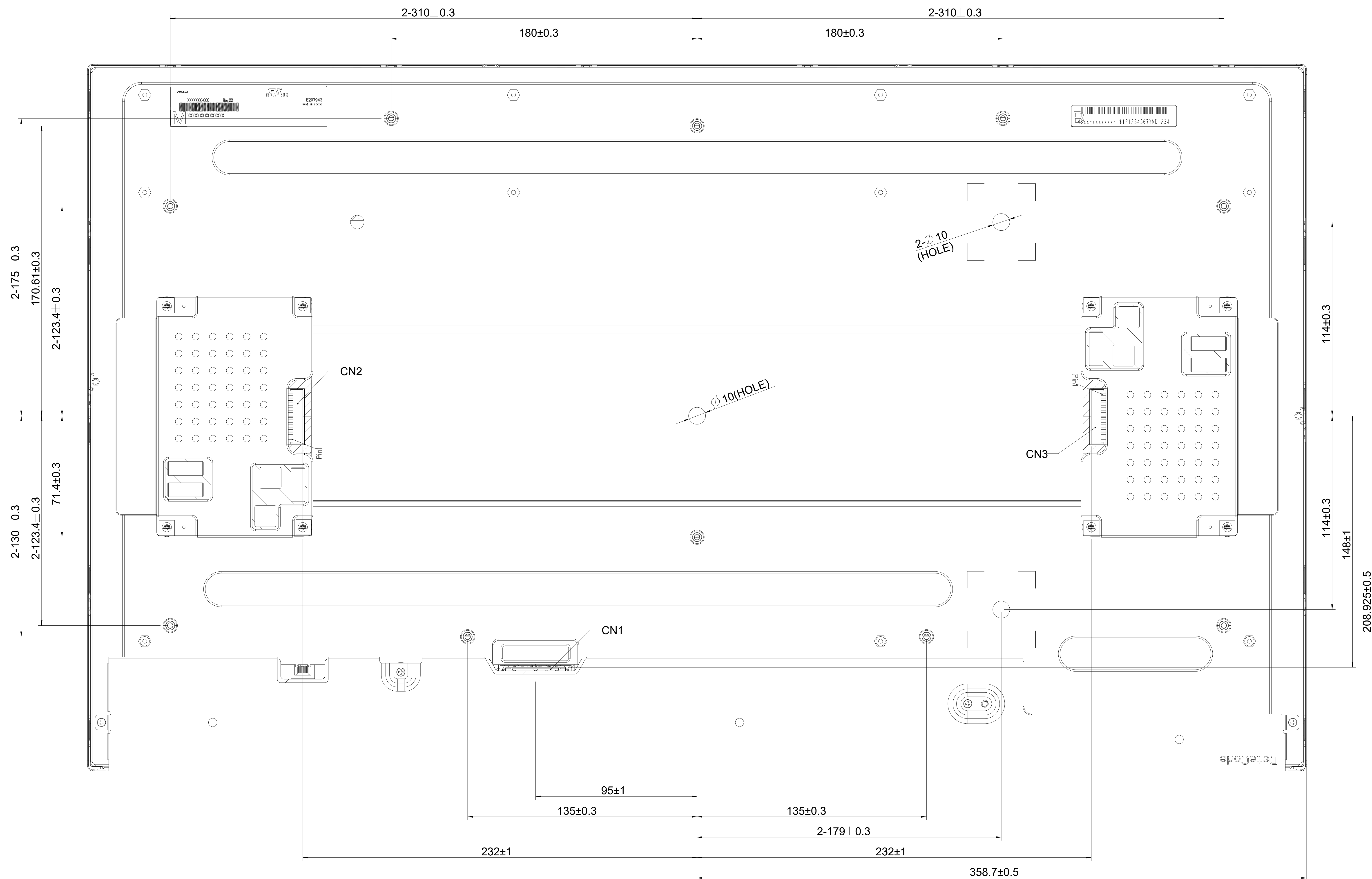
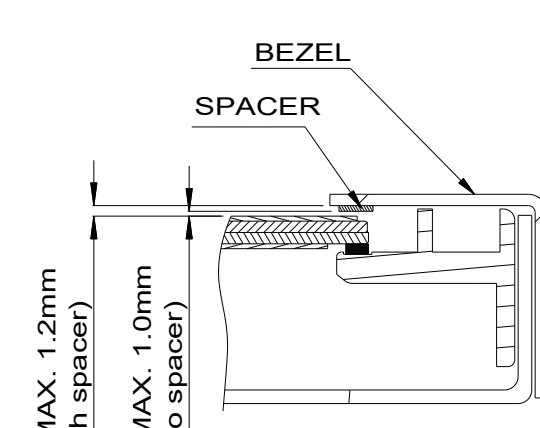
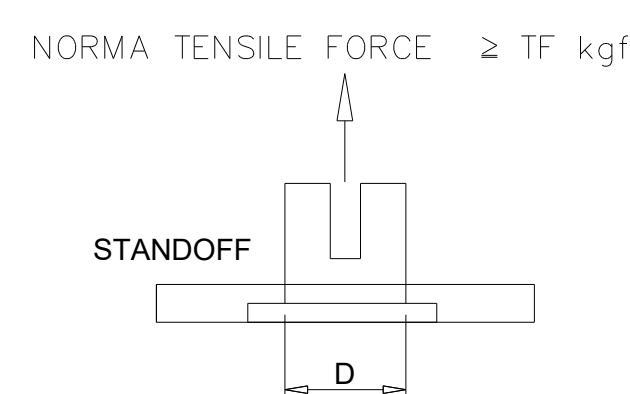
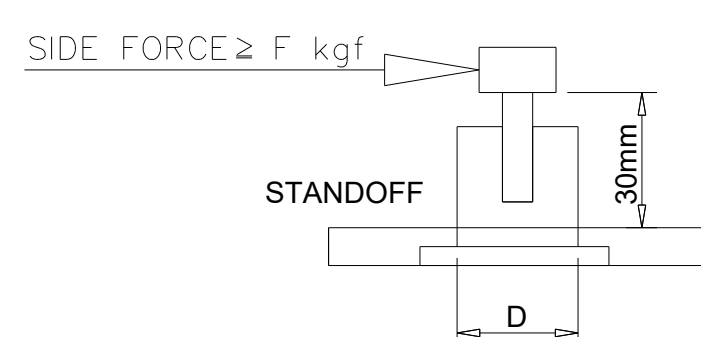


FIG.1



SECTION GAP BTW BEZEL AND POL.



NOTES:

- 1.UNSPECIFIED TOLERANCE: 0.5mm.
- 2.MODULE BACKSIDE CAN'T WITHSTAND ANYTHING EXCEPT USER HOLE.
- 3.DISPLAY AREA POSITION TOLERANCE: |A-B|≤1.0mm & |C-D|≤1.0mm(SEE FIG.1).
- 4.USER HOLE(STANDOFF):M3, PITCH=0.5/MACHINE, MAX. TORQUE=5.0kgf-cm, MAX. DEPTH=10.0mm
DIAMETER=5.5mm, SIDE FORCE(MAX.)=20kgf,NOMAL TENSILE FORCE(MAX.)=40kgf
- 4.CONNECTOR TYPE:
CN1:1st,P-TWO,187059-51221
2nd,FCN,WF23-402-5133
CN2/CN3:1st,FCN,JH2-D2-143N
2nd,Cvilux,CI0114M1HR0-H

REV	EC NUMBER	DESCRIPTION	DATE
1		First Release	2014-05-05

TYPE	CONTROL	DATE	SCALE	UNIT	REVISION
APPROVED	NA	2014-05-05	1:1	mm	01
CHECKED	NA	2014-05-05			22
DESIGNED	Wish Huang	2014-05-05			AD